

VERTICAL DEFLECTION CIRCUIT

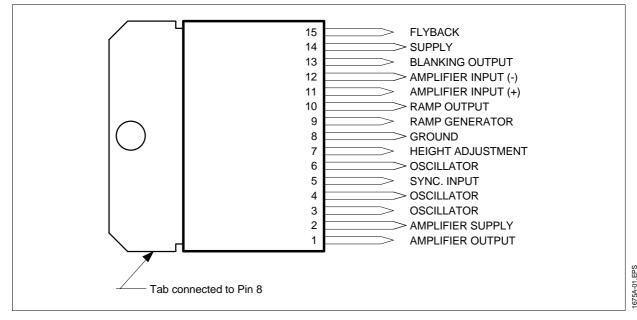
- SYNCHRONISATION CIRCUIT
- ESD PROTECTED
- PRECISION OSCILLATOR AND RAMP GENERATOR
- POWER OUTPUT AMPLIFIER WITH HIGH CURRENT CAPABILITY
- FLYBACK GENERATOR
- VOLTAGE REGULATOR
- PRECISION BLANKING PULSE GENERATOR
- THERMAL SHUT DOWN PROTECTION
- CRT SCREEN PROTECTION CIRCUIT WHICH BLANKS THE BEAM CURRENT IN THE EVENT OF LOSS OF VERTICAL DE-FLECTION CURRENT

DESCRIPTION

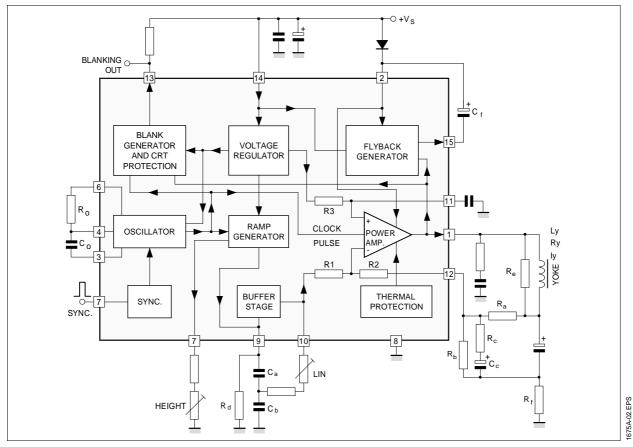
The TDA1675A is a monolithic integrated circuit in 15-lead Multiwatt[®] package. It is a full performance and very efficient vertical deflection circuit intended for direct drive of the yoke of 110^o colour TV picture tubes. It offers a wide range of applications also in portable CTVs, B&W TVs, monitors and displays.



PIN CONNECTIONS (top view)



BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
Vs	Supply Voltage at Pin 14	35	V
V ₁ , V ₂	Flyback Peak Voltage	65	V
V5	Sync. Input Voltage	20	V
V ₁₁ , V ₁₂	Power Amplifier Input Voltage	V _S - 10	V
V ₁₃	Voltage at Pin 13	Vs	
lo	Output Current (non repetitive) at t = 2ms	3	Α
lo	Output Peak Current at f = 50Hz t > 10µs	2	Α
lo	Output Peak Current at f = $50Hz t \le 10 \mu s$	3.5	Α
I ₁₅	Pin 15 Peak-to-peak Flyback Current at f = 50Hz, tfly ≤ 1.5ms	3	Α
I ₁₅	Pin 15 D.C. Current at V1 < V ₁₄	100	mA
P _{tot}	Maximum Power Dissipation at $T_{case} \le 60^{\circ}C$	30	W
T _{stg} , T _j	Storage and Junction Temperature	- 40, + 150	°C

THERMAL DATA

Symbol	Parameter	Value	
R _{TH(j-c)}	Thermal Resistance Junction-case Max.	3	°C/W
R _{TH(j-a)}	Thermal Resistance Junction-ambient Max.	40	°C/W



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	Fig.
l ₂	Pin 2 quiescent current	l ₁ = 0		16	36	mA	1b
- I ₉	Ramp generator bias current	$V_9 = 0$		0.02	1	μΑ	1b
- I 9	Ramp generator current	$V_9 = 0$; - $I_7 = 20\mu A$	18.5	20	21.5	μΑ	1b
$\frac{ \Delta _{9} }{ _{9}}$	Ramp generator non linearity	$\Delta V_9 = 0$ to 15V, - I ₇ = 20 μ A		0.2	1	%	1b
I ₁₄	Pin 14 quiescent current			25	45	mA	1b
V ₁	Quiescent output voltage	$\begin{array}{l} V_S=35V,\ R_a=2.2k\Omega,\ R_b=1k\Omega\\ V_S=15V,\ R_a=390\Omega,\ R_b=1k\Omega \end{array}$	16.4 6.9	17.8 7.5	19.5 8.1	V V	1a
V_{1L}	Output saturation voltage to ground	I ₁ = 1.2A,		1	1.4	V	1c
V_{1H}	Output saturation voltage to supply	- I ₁ = 1.2A		1.6	2.2	V	1d
V4	Oscillator virtual ground			0.45		V	1b
V ₇	Regulated voltage at pin 7	$-I_7 = 20\mu A$	6.3	6.6	7	V	1b
$\frac{\Delta V_{7}}{\Delta V_{S}}$	Regulated voltage drift with supply voltage	ΔV_{S} = 15 to 35V		1	2	$\frac{mV}{V}$	1b
V ₁₁	Amplifier input (+) reference voltage		4.1	4.4	4.7	V	1b
V ₁₃	Blanking output saturation voltage	I ₁₃ = 10 mA		0.35	0.5	V	1a
V ₁₅	Pin 15 saturation voltage to ground	I ₁₅ = 20 mA		1	1.5	V	1a

DC ELECTRICAL CHARACTERISTICS (Vs = 35V, T_{amb} = 25°C, unless otherwise specified)

Figure 1 : DC Test Circuit.

Figure 1a

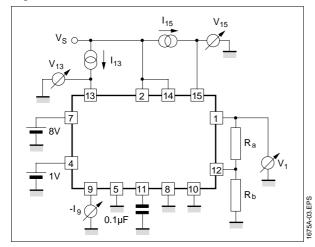


Figure 1c

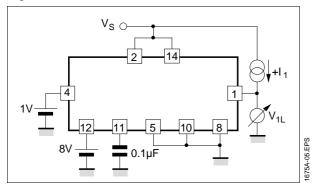


Figure 1b

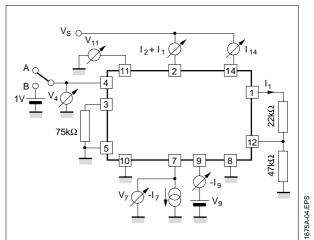
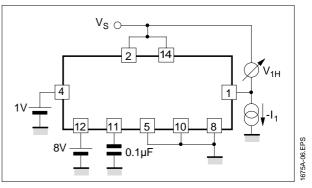


Figure 1d



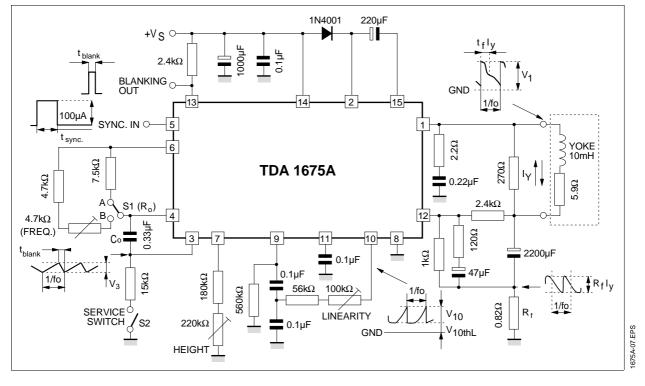


AC ELECTRICAL CHARACTERISTICS

(Refer to A.C. test circuit of fig. 2, $T_{amb} = 25^{\circ}C$, $V_S = 24V$, f = 50Hz, unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _S	Supply Current	$I_{\rm Y} = 2A_{\rm PP}$		295		mA
I ₅	Sync Input Current Required to Sync		100			μA
V ₁	Flyback Voltage	I _y = 2App		50		V
V ₃	Peak-to-peak Oscillator Sawtooth Voltage	$I_5 = 0$ $I_5 = 100 \mu A$		3.6 3.4		V V
V _{10TH(L)}	Start Scan Level of the Input Ramp			1.85		V
t _{FLY}	Flyback Time	ly = 2App		0.6		ms
t BLANK	Blanking Pulse Duration	$f_o = 50Hz, T_j = 75^{\circ}C$ $f_o = 60Hz, T_j = 75^{\circ}C$	1.33	1.4 1.17	1.47	ms ms
fo	Free Running Frequency	$\begin{array}{l} {\sf R}_{o} = 7.5 k\Omega, {\sf C}_{o} = 330 n {\sf F}, {\sf T}_{j} = 75^{o} {\sf C} \\ {\sf R}_{o} = 6.2 k\Omega, {\sf C}_{o} = 330 n {\sf F}, {\sf T}_{j} = 75^{o} {\sf C} \end{array}$	42	43.5 52.5	46	Hz Hz
Δf	Synchronization Range	$I_5 = 100 \mu A, T_j = 75^{\circ}C$	14	16		Hz
Tj	Junction Temperature for Thermal Shut-down			145		°C
Von	Peak-to-peak Output Noise				35	mV_{PP}

Figure 2 : AC Test Circuit



SGS-THOMSON MICROELECTRONICS

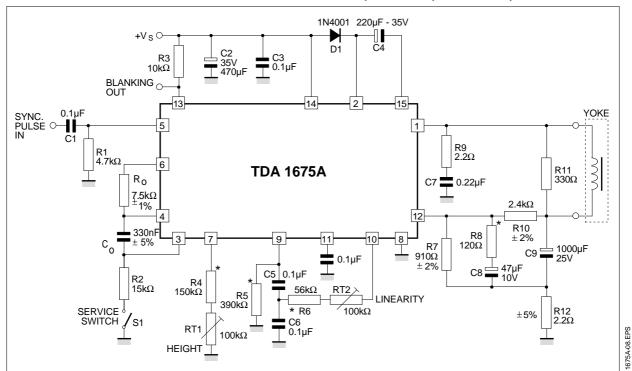


Figure 3 : Application Circuit for Small Scree 90^o CTV Set ($R_y = 15\Omega$; $L_y = 30 \text{ mH}$; $I_y = 0.82 \text{ App}$)

* The value depends on the characteristics of the CRT. The value shown is indicative only.

TYPICAL PERFORMANCE

Symbol	Parameter	Value	Unit	
Vs	Minimum supply voltage	25	V	
Is	Supply current	140	mA	
t _{FLY}	Flyback time	0.7	ms	
t _{BLKG}	Banking time	1.4	ms	
fo	Free running frequency	43.5	Hz	
* Ртот	Power dissipation	2.4	W	
* R _{TH(heatsink)}	Thermal resistance of the heatsink for $T_{amb} = 60^{\circ}C$ and $T_{jmax} = 110^{\circ}C$ for $T_{amb} = 60^{\circ}C$ and $T_{jmax} = 120^{\circ}C$	13 16	°C/W °C/W	

* Worst case condition.



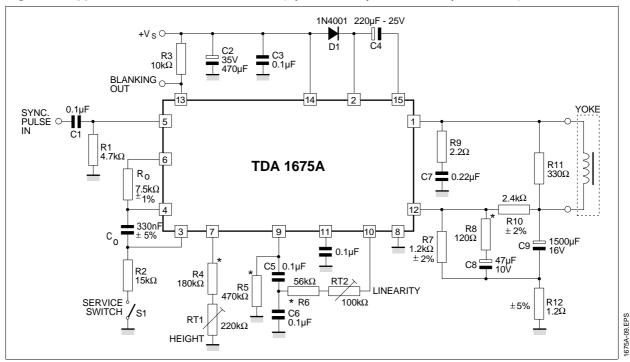


Figure 4 : Application Circuit for 110° CTV Set (R_y = 9.6 Ω ; L_y = 24.6 mH; I_y = 1.2 APP)

* The value depends on the characteristics of the CRT. The value shown is indicative only.

TYPICAL PERFORMANCE

Symbol	Parameter	Value	Unit
Vs	Minimum supply voltage	22.5	V
Is	Supply current	185	mA
t _{FLY}	Flyback time	1	ms
t BLKG	Banking time	1.4	ms
fo	Free running frequency	43.5	Hz
* P _{TOT}	Power dissipation	2.7	W
* RTH(heatsink)	Thermal resistance of the heatsink for Tamb = 60° C and T _{j max} = 110° C for T _{amb} = 60° C and T _{j max} = 120° C	11.5 14.5	°C/W °C/W

* Worst case condition.



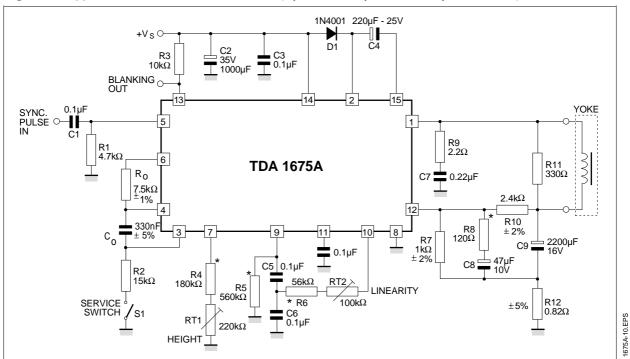


Figure 5 : Application Circuit for 110° CTV Set (R_y = 5.9 Ω ; L_y = 10 mH ; I_y = 1.95 App)

* The value depends on the characteristics of the CRT. The value shown is indicative only.

TYPICAL PERFORMANCE

Symbol	Parameter	Value	Unit	
Vs	Minimum supply voltage	24	V	
ls	Supply current	285	mA	
t _{FLY}	Flyback time	0.6	ms	
t BLKG	Banking time	1.4	ms	
fo	Free running frequency	43.5	Hz	
* P _{TOT}	Power dissipation	4.3	W	
* R _{TH} (heatsink)	Thermal resistance of the heatsink for Tamb = 60° C and T _{j max} = 110° C for T _{amb} = 60° C and T _{j max} = 120° C	6.5 8.5	°C/W °C/W	

* Worst case condition.



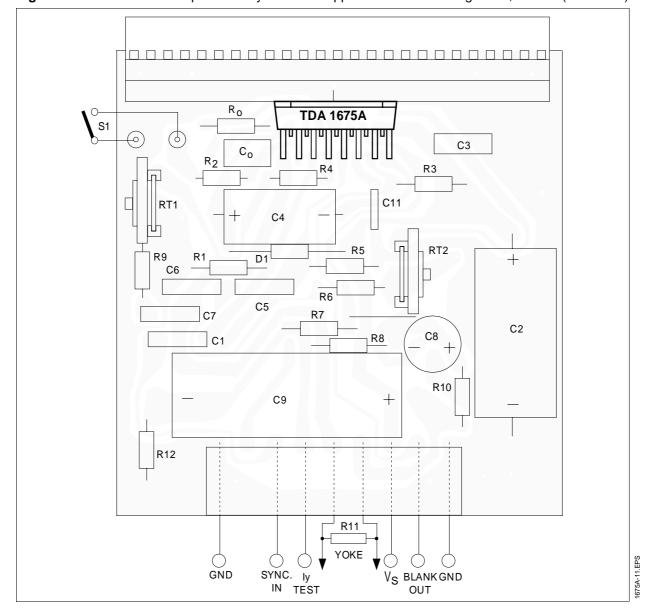


Figure 6: PC Board and Components Layout for the Application Circuits of Figures 3, 4 and 5 (1: 1 scale)

APPLICATION INFORMATION (Refer to the block diagram)

Oscillator and sync gate (Clock generation)

The oscillator is obtained by means of an integrator driven by a two threshold circuit that switches R_0 high or low so allowing the charge or the discharge of C_0 under constant current conditions.

The Sync input pulse at the Sync gate lowers the level of the upper threshold and than it controls the period duration. A clock pulse is generated.

Pin 4 is the inverting input of the amplifier used as integrator.

- **Pin 6** is the output of the switch driven by the internal clock pulse generated by the threshold circuits.
- Pin 3 is the output of the amplifier.
- **Pin 5** is the input for sync pulses (positive)

Ramp generator and buffer stage

A current mirror, the current intensity of which can be externally adjusted, charges one capacitor producing a linear voltage ramp.

The internal clock pulse stops the increasing ramp by a very fast discharge of the capacitor a new voltage ramp is immediately allowed.



The required value of the capacitance is obtained by means of the series of two capacitors Ca and Cb, which allow the linearity control by applying a feedback between the output of the buffer and the tapping from C_a and C_b .

- **Pin 7** The resistance between pin 7 and ground defines the current mirror current and than the height of the scanning.
- **Pin 9** is the output of the current mirror that charges the series of C_a and C_b. This pin is also the input of the buffer stage.
- **Pin 10** is the output of the buffer stage and it is internally coupled to the inverting input of the power amplifier through R1.

Power amplifier

This amplifier is a voltage-to-current power converter, the transconductance of which is externally defined by means of a negative current feedback.

The output stage of the power amplifier is supplied by the main supply during the trace period, and by the flyback generator circuit during the most of the duration of the flyback time. The internal clock turns off the lower power output stage to start the flyback.

The power output stage is thermally protected by sensing the junction temperature and then by putting off the current sources of the power stage.

- Pin 12 is the inverting input of the amplifier. An external network, R_a and R_b, defines the DClevel across C_y so allowing a correct centering of the output voltage. The series network R_c and C_c, in conjunction with R_a and R_b, applies at the feedback input I₂ a small part of the parabola, available across C_y, and AC feedback voltage, taken across R_f. The external components R_c, R_a and R_d, produce the linearity correction on the output scanning currently and their values must be optimized for each type of CRT.
- **Pin 11** is the non-inverting input. At this pin the non-inverting input reference voltage supplied by the voltage regulator can be measured. A capacitor must be connected to increase the performances from the noise point of view.
- Pin 1 is the output of the power amplifier and it drives the yoke by a negative slope cur-

rent ramply. Re and the Boucherot cell are used to stabilize the power amplifier.

Pin 2 The supply of the power output stage is forced at this pin. During the trace time the supply voltage is obtained from the main supply voltage V_S by a diode, while during the retrace time this pin is supplied from the flyback generator.

Flyback generator

This circuit supplies both the power amplifier output stage and the yoke during the most of the duration of the flyback time (retrace).

The internal clock opens the loop of the amplifier and lets pin 1 floating so allowing the rising of the flyback. Crossing the main supply voltage at pin 14, the flyback pulse front end drives the flyback generator in such a way allowing its output to reach and overcome the main supply voltage, starting from a low condition forced during the trace period.

An integrated diode stops the rising of this output increase and the voltage jump is transferred by means of capacitor C_f at the supply voltage pin of the power stage (pin 2).

When the current across the yoke changes its direction, the output of the flyback generator falls down to the main supply voltage and it is stopped by means of the saturated output darlington at a high level. At this time the flyback generator starts to supply the power output amplifier output stage by a diode inside the device. The flyback generator supplies the yoke too.

Later, the increasing flyback current reaches the peak value and then the flyback time is completed: the trace period restarts. The output of the power amplifier (pin 1) falls under the main supply voltage and the output of the flyback generator is driven for a low state so allowing the flyback capacitor Cf to restore the energy lost during the retrace.

Pin 15 is the output of the flyback generator that, when driven, jumps from low to high condition. An external capacitor C_f transfers the jump to pin 2 (see pin 2).

Blanking generator and CRT protection

This circuit is a pulse shaper and its output goes high during the blanking period or for CRT protection. The input is internally driven by the clock pulse that defines the width of the blanking time



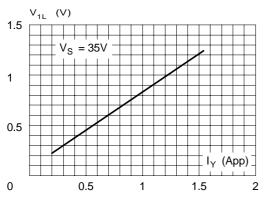
when a flyback pulse has been generated. If the flyback pulse is absent (short cirucit or open cirucit of the yoke), the blanking output remains high so allowing the CRT protection.

Pin 13 is an open collector output where the blanking pulse is available.

Voltage regulator

The main supply voltage V_S , is lowered and regulated internally to allow the required reference voltages for all the above described blocks.

- Pin 8 is the GND pin or the negative input of Vs
- Figure 7 : Output Saturation Voltage to Ground vs. Peak Output Current



MOUNTING INSTRUCTIONS

The power dissipated in the circuit must be removed by adding an external heatsink. Thanks to the MULTIWATT ® package attaching the heatsink is very simple, a screw or a compression

Figure 10 : Mounting Examples

Figure 8 : Output Saturation Voltage to Supply versus Output Peak Current

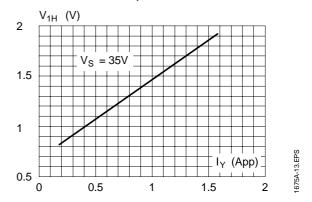
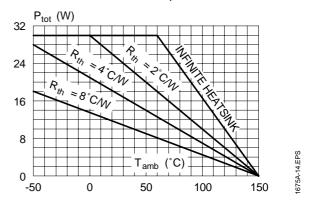
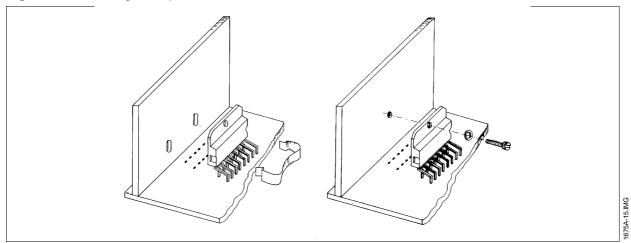


Figure 9 : Maximum allowable Power Dissipation vs. Ambient Temperature



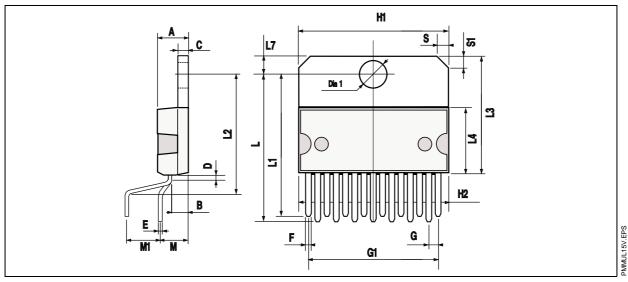
spring (clip) being sufficient. Between the heatsink and the package, it is better to insert a layer of silicon grease, to optimize the thermal contact; no electrical isolation is needed between the two surfaces.



675A-12.EPS



PACKAGE MECHANICAL DATA: 15 PINS - PLASTIC MULTIWATT



Dimensione		Millimeters			Inches	
Dimensions	Min.	Тур.	Max.	Min.	Тур.	Max.
А			5			0.197
В			2.65			0.104
С			1.6			0.063
D		1			0.039	
Е	0.49		0.55	0.019		0.022
F	0.66		0.75	0.026		0.030
G	1.14	1.27	1.4	0.045	0.050	0.055
G1	17.57	17.78	17.91	0.692	0.700	0.705
H1	19.6			0.772		
H2			20.2			0.795
L	22.1		22.6	0.870		0.890
L1	22		22.5	0.866		0.886
L2	17.65		18.1	0.695		0.713
L3	17.25	17.5	17.75	0.679	0.689	0.699
L4	10.3	10.7	10.9	0.406	0.421	0.429
L7	2.65		2.9	0.104		0.114
М	4.2	4.3	4.6	0.165	0.169	0.181
M1	4.5	5.08	5.3	0.177	0.200	0.209
S	1.9		2.6	0.075		0.102
S1	1.9		2.6	0.075		0.102
Dia. 1	3.65		3.85	0.144		0.152

Information furnished is believed to be accurate and reliable. However, SGS-THOMSON Microelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No licence is granted by implication or otherwise under any patent or patent rights of SGS-THOMSON Microelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. SGS-THOMSON Microelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of SGS-THOMSON Microelectronics.

© 1994 SGS-THOMSON Microelectronics - All Rights Reserved

Purchase of I²C Components of SGS-THOMSON Microelectronics, conveys a license under the Philips I²C Patent. Rights to use these components in a I²C system, is granted provided that the system conforms to the I²C Standard Specifications as defined by Philips.

SGS-THOMSON Microelectronics GROUP OF COMPANIES

Australia - Brazil - China - France - Germany - Hong Kong - Italy - Japan - Korea - Malaysia - Malta - Morocco The Netherlands - Singapore - Spain - Sweden - Switzerland - Taiwan - Thailand - United Kingdom - U.S.A.

